

Voltage Detector IC Series

Standard CMOS Voltage Detector IC



BD48xxx series BD49xxx series

●General Description

ROHM's BD48xxx and BD49xxx series are highly accurate, low current consumption reset IC series. The line up includes BD48xxx devices with N channel open drain output and BD49xxx devices with CMOS output. The devices are available for specific detection voltages ranging from 2.3V to 6.0V in increments of 0.1V.

●Features

- High accuracy detection
- Ultra-low current consumption
- Two output types (Nch open drain and CMOS output)
- Wide Operating temperature range
- Very small and low height package
- Package SSOP5 is similar to SOT-23-5 (JEDEC)
- Package SSOP3 is similar to SOT-23-3 (JEDEC)

●Key Specifications

- Detection voltage: 2.3V to 6.0V (Typ.),
0.1V steps
- High accuracy detection voltage: $\pm 1.0\%$
- Ultra-low current consumption: 0.9 μ A (Typ.)
- Operating temperature range: -40°C to +105°C

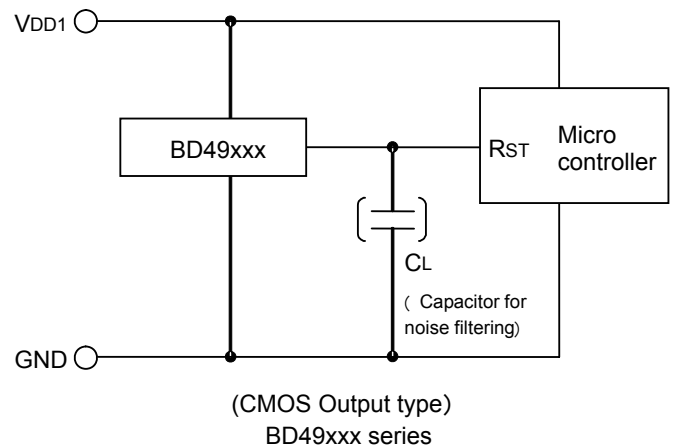
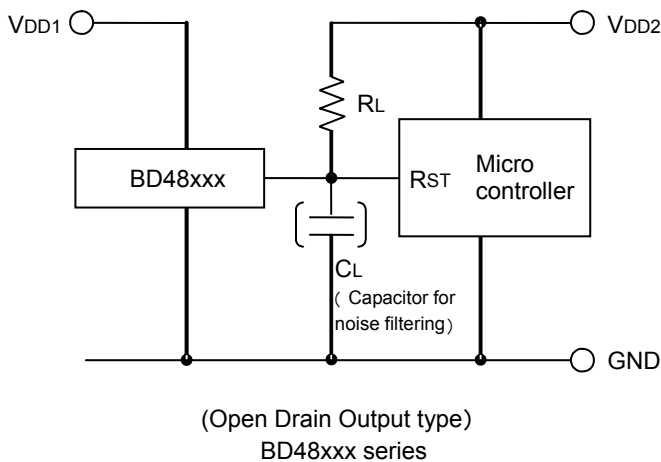
●Package

- SSOP5: 2.90mm x 2.80mm x 1.15mm
- SSOP3: 2.90mm x 2.80mm x 1.15mm
- VSO5: 1.60 mm x 1.60mm x 0.60mm

●Applications

Circuits using microcontrollers or logic circuits that require a reset.

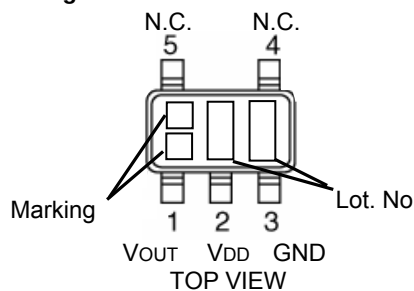
●Typical Application Circuit



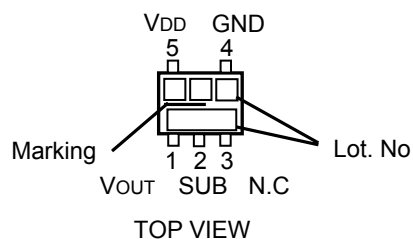
○Product structure: Silicon monolithic integrated circuit ○This product is not designed protection against radioactive rays.

● Connection Diagram

SSOP5



VSOF5



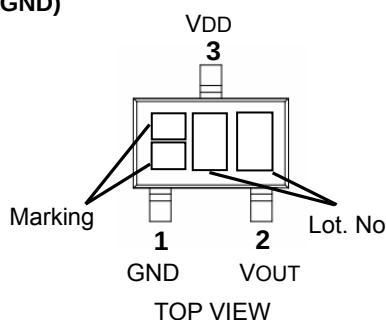
● Pin Descriptions

SSOP5		
PIN No.	Symbol	Function
1	VOUT	Reset Output
2	VDD	Power Supply Voltage
3	GND	GND
4	N.C.	Unconnected Terminal
5	N.C.	Unconnected Terminal

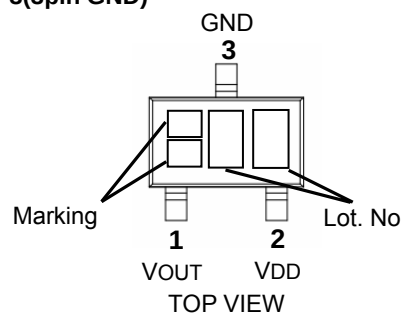
VSOF5		
PIN No.	Symbol	Function
1	VOUT	Reset Output
2	SUB	Substrate*
3	N.C.	Unconnected Terminal
4	GND	GND
5	VDD	Power Supply Voltage

*Connect the substrate to GND.

SSOP3(1pin GND)



SSOP3(3pin GND)



● Pin Descriptions

SSOP3-1		
PIN No.	Symbol	Function
1	GND	GND
2	VOUT	Reset Output
3	VDD	Power Supply Voltage

SSOP3-2		
PIN No.	Symbol	Function
1	VOUT	Reset Output
2	VDD	Power Supply Voltage
3	GND	GND

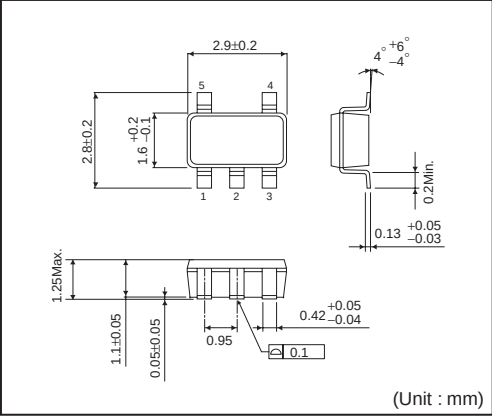
● Ordering Information

B	D	x	x	x	x	x	x	-	T	R
---	---	---	---	---	---	---	---	---	---	---

Part Number	Output Type 48 : Open Drain 49 : CMOS	Package1	Reset Voltage Value 23 : 2.3V ↓ 60 : 6.0V 0.1V step	Package2	Packageing and forming specification Embossed tape and reel TR :The pin number 1 is the upper right :SSOP5 :VSOF5 TL :The pin number 1 is the upper left :SSOP3-1 :SSOP3-2
		Package1	Package2	Package name	
		E	G	SSOP5	
		K	G	SSOP3(1pin GND)	
		L	G	SSOP3(3pin GND)	
		Blank	FVE	VSOF5	
		Blank	G	SSOP5	

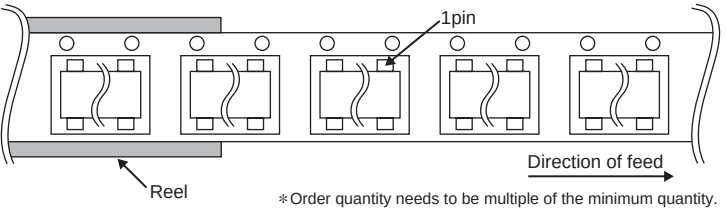
note) Please be new and, in hope of SSOP5, choose the package 1 by "E" and package 2" G."

SSOP5

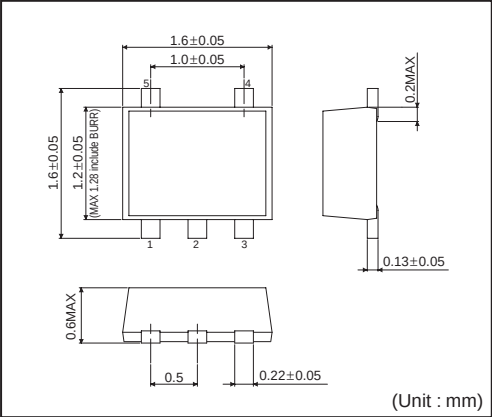


<Tape and Reel information>

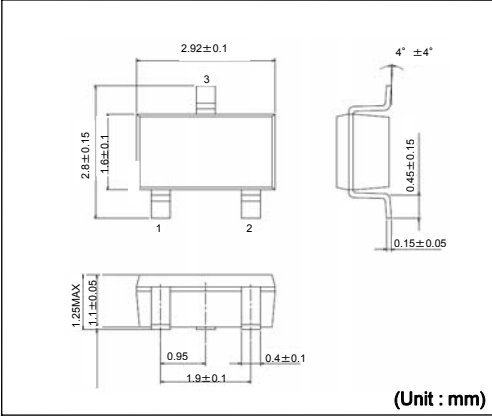
Tape	Embossed carrier tape
Quantity	3000pcs
Direction of feed	TR (The direction is the 1pin of product is at the upper right when you hold reel on the left hand and you pull out the tape on the right hand)



VSOF5

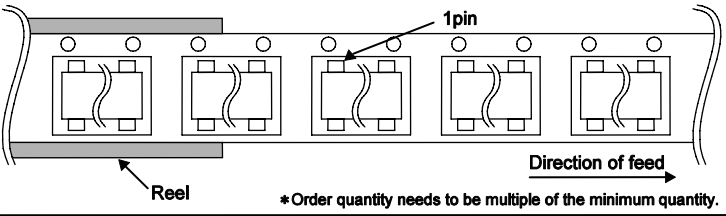


SSOP3



<Tape and Reel information>

Tape	Embossed carrier tape
Quantity	3000pcs
Direction of feed	TL (The direction is the 1pin of product is at the upper right when you hold reel on the left hand and you pull out the tape on the right hand)



●Lineup

Marking	Detection Voltage	Part Number	Marking	Detection Voltage	Part Number	Marking	Detection Voltage	Part Number	Marking	Detection Voltage	Part Number
EW	6.0V	BD4860	EB	4.1V	BD4841	GW	6.0V	BD4960	GB	4.1V	BD4941
EV	5.9V	BD4859	EA	4.0V	BD4840	GV	5.9V	BD4959	GA	4.0V	BD4940
EU	5.8V	BD4858	DV	3.9V	BD4839	GU	5.8V	BD4958	FV	3.9V	BD4939
ET	5.7V	BD4857	DU	3.8V	BD4838	GT	5.7V	BD4957	FU	3.8V	BD4938
ES	5.6V	BD4856	DT	3.7V	BD4837	GS	5.6V	BD4956	FT	3.7V	BD4937
ER	5.5V	BD4855	DS	3.6V	BD4836	GR	5.5V	BD4955	FS	3.6V	BD4936
EQ	5.4V	BD4854	DR	3.5V	BD4835	GQ	5.4V	BD4954	FR	3.5V	BD4935
EP	5.3V	BD4853	DQ	3.4V	BD4834	GP	5.3V	BD4953	FQ	3.4V	BD4934
EN	5.2V	BD4852	DP	3.3V	BD4833	GN	5.2V	BD4952	FP	3.3V	BD4933
EM	5.1V	BD4851	DN	3.2V	BD4832	GM	5.1V	BD4951	FN	3.2V	BD4932
EL	5.0V	BD4850	DM	3.1V	BD4831	GL	5.0V	BD4950	FM	3.1V	BD4931
EK	4.9V	BD4849	DL	3.0V	BD4830	GK	4.9V	BD4949	FL	3.0V	BD4930
EJ	4.8V	BD4848	DK	2.9V	BD4829	GJ	4.8V	BD4948	FK	2.9V	BD4929
EH	4.7V	BD4847	DJ	2.8V	BD4828	GH	4.7V	BD4947	FJ	2.8V	BD4928
EG	4.6V	BD4846	DH	2.7V	BD4827	GG	4.6V	BD4946	FH	2.7V	BD4927
EF	4.5V	BD4845	DG	2.6V	BD4826	GF	4.5V	BD4945	FG	2.6V	BD4926
EE	4.4V	BD4844	DF	2.5V	BD4825	GE	4.4V	BD4944	FF	2.5V	BD4925
ED	4.3V	BD4843	DE	2.4V	BD4824	GD	4.3V	BD4943	FE	2.4V	BD4924
EC	4.2V	BD4842	DD	2.3V	BD4823	GC	4.2V	BD4942	FD	2.3V	BD4923

Marking	Detection Voltage	Part Number	Marking	Detection Voltage	Part Number	Marking	Detection Voltage	Part Number	Marking	Detection Voltage	Part Number
Cm	6.0V	BD48E60	Be	4.1V	BD48E41	Ff	6.0V	BD49E60	Ea	4.1V	BD49E41
Ck	5.9V	BD48E59	Bd	4.0V	BD48E40	Fe	5.9V	BD49E59	Dy	4.0V	BD49E40
Ch	5.8V	BD48E58	Bc	3.9V	BD48E39	Fd	5.8V	BD49E58	Dr	3.9V	BD49E39
Cg	5.7V	BD48E57	Bb	3.8V	BD48E38	Fc	5.7V	BD49E57	Dp	3.8V	BD49E38
Cf	5.6V	BD48E56	Ba	3.7V	BD48E37	Fb	5.6V	BD49E56	Dn	3.7V	BD49E37
Ce	5.5V	BD48E55	Ay	3.6V	BD48E36	Fa	5.5V	BD49E55	Dm	3.6V	BD49E36
Cd	5.4V	BD48E54	Ar	3.5V	BD48E35	Ey	5.4V	BD49E54	Dk	3.5V	BD49E35
Cc	5.3V	BD48E53	Ap	3.4V	BD48E34	Er	5.3V	BD49E53	Dh	3.4V	BD49E34
Cb	5.2V	BD48E52	An	3.3V	BD48E33	Ep	5.2V	BD49E52	Dg	3.3V	BD49E33
Ca	5.1V	BD48E51	Am	3.2V	BD48E32	En	5.1V	BD49E51	Df	3.2V	BD49E32
By	5.0V	BD48E50	Ak	3.1V	BD48E31	Em	5.0V	BD49E50	De	3.1V	BD49E31
Br	4.9V	BD48E49	Ah	3.0V	BD48E30	Ek	4.9V	BD49E49	Dd	3.0V	BD49E30
Bp	4.8V	BD48E48	Ag	2.9V	BD48E29	Eh	4.8V	BD49E48	Dc	2.9V	BD49E29
Bn	4.7V	BD48E47	Af	2.8V	BD48E28	Eg	4.7V	BD49E47	Db	2.8V	BD49E28
Bm	4.6V	BD48E46	Ae	2.7V	BD48E27	Ef	4.6V	BD49E46	Da	2.7V	BD49E27
Bk	4.5V	BD48E45	Ad	2.6V	BD48E26	Ee	4.5V	BD49E45	Cy	2.6V	BD49E26
Bh	4.4V	BD48E44	Ac	2.5V	BD48E25	Ed	4.4V	BD49E44	Cr	2.5V	BD49E25
Bg	4.3V	BD48E43	Ab	2.4V	BD48E24	Ec	4.3V	BD49E43	Cp	2.4V	BD49E24
Bf	4.2V	BD48E42	Aa	2.3V	BD48E23	Eb	4.2V	BD49E42	Cn	2.3V	BD49E23

Marking	Detection Voltage	Part Number	Marking	Detection Voltage	Part Number	Marking	Detection Voltage	Part Number	Marking	Detection Voltage	Part Number
Cm	6.0V	BD48K60	Be	4.1V	BD48K41	Ff	6.0V	BD49K60	Ea	4.1V	BD49K41
Ck	5.9V	BD48K59	Bd	4.0V	BD48K40	Fe	5.9V	BD49K59	Dy	4.0V	BD49K40
Ch	5.8V	BD48K58	Bc	3.9V	BD48K39	Fd	5.8V	BD49K58	Dr	3.9V	BD49K39
Cg	5.7V	BD48K57	Bb	3.8V	BD48K38	Fc	5.7V	BD49K57	Dp	3.8V	BD49K38
Cf	5.6V	BD48K56	Ba	3.7V	BD48K37	Fb	5.6V	BD49K56	Dn	3.7V	BD49K37
Ce	5.5V	BD48K55	Ay	3.6V	BD48K36	Fa	5.5V	BD49K55	Dm	3.6V	BD49K36
Cd	5.4V	BD48K54	Ar	3.5V	BD48K35	Ey	5.4V	BD49K54	Dk	3.5V	BD49K35
Cc	5.3V	BD48K53	Ap	3.4V	BD48K34	Er	5.3V	BD49K53	Dh	3.4V	BD49K34
Cb	5.2V	BD48K52	An	3.3V	BD48K33	Ep	5.2V	BD49K52	Dg	3.3V	BD49K33
Ca	5.1V	BD48K51	Am	3.2V	BD48K32	En	5.1V	BD49K51	Df	3.2V	BD49K32
By	5.0V	BD48K50	Ak	3.1V	BD48K31	Em	5.0V	BD49K50	De	3.1V	BD49K31
Br	4.9V	BD48K49	Ah	3.0V	BD48K30	Ek	4.9V	BD49K49	Dd	3.0V	BD49K30
Bp	4.8V	BD48K48	Ag	2.9V	BD48K29	Eh	4.8V	BD49K48	Dc	2.9V	BD49K29
Bn	4.7V	BD48K47	Af	2.8V	BD48K28	Eg	4.7V	BD49K47	Db	2.8V	BD49K28
Bm	4.6V	BD48K46	Ae	2.7V	BD48K27	Ef	4.6V	BD49K46	Da	2.7V	BD49K27
Bk	4.5V	BD48K45	Ad	2.6V	BD48K26	Ee	4.5V	BD49K45	Cy	2.6V	BD49K26
Bh	4.4V	BD48K44	Ac	2.5V	BD48K25	Ed	4.4V	BD49K44	Cr	2.5V	BD49K25
Bg	4.3V	BD48K43	Ab	2.4V	BD48K24	Ec	4.3V	BD49K43	Cp	2.4V	BD49K24
Bf	4.2V	BD48K42	Aa	2.3V	BD48K23	Eb	4.2V	BD49K42	Cn	2.3V	BD49K23

Marking	Detection Voltage	Part Number	Marking	Detection Voltage	Part Number	Marking	Detection Voltage	Part Number	Marking	Detection Voltage	Part Number
Kb	6.0V	BD48L60	Gn	4.1V	BD48L41	Np	6.0V	BD49L60	Mg	4.1V	BD49L41
Ka	5.9V	BD48L59	Gm	4.0V	BD48L40	Nn	5.9V	BD49L59	Mf	4.0V	BD49L40
Hy	5.8V	BD48L58	Gk	3.9V	BD48L39	Nm	5.8V	BD49L58	Me	3.9V	BD49L39
Hr	5.7V	BD48L57	Gh	3.8V	BD48L38	Nk	5.7V	BD49L57	Md	3.8V	BD49L38
Hp	5.6V	BD48L56	Gg	3.7V	BD48L37	Nh	5.6V	BD49L56	Mc	3.7V	BD49L37
Hn	5.5V	BD48L55	Gf	3.6V	BD48L36	Ng	5.5V	BD49L55	Mb	3.6V	BD49L36
Hm	5.4V	BD48L54	Ge	3.5V	BD48L35	Nf	5.4V	BD49L54	Ma	3.5V	BD49L35
Hk	5.3V	BD48L53	Gd	3.4V	BD48L34	Ne	5.3V	BD49L53	Ky	3.4V	BD49L34
Hh	5.2V	BD48L52	Gc	3.3V	BD48L33	Nd	5.2V	BD49L52	Kr	3.3V	BD49L33
Hg	5.1V	BD48L51	Gb	3.2V	BD48L32	Nc	5.1V	BD49L51	Kp	3.2V	BD49L32
Hf	5.0V	BD48L50	Ga	3.1V	BD48L31	Nb	5.0V	BD49L50	Kn	3.1V	BD49L31
He	4.9V	BD48L49	Fy	3.0V	BD48L30	Na	4.9V	BD49L49	Km	3.0V	BD49L30
Hd	4.8V	BD48L48	Fr	2.9V	BD48L29	My	4.8V	BD49L48	Kk	2.9V	BD49L29
Hc	4.7V	BD48L47	Fp	2.8V	BD48L28	Mr	4.7V	BD49L47	Kh	2.8V	BD49L28
Hb	4.6V	BD48L46	Fn	2.7V	BD48L27	Mp	4.6V	BD49L46	Kg	2.7V	BD49L27
Ha	4.5V	BD48L45	Fm	2.6V	BD48L26	Mn	4.5V	BD49L45	Kf	2.6V	BD49L26
Gy	4.4V	BD48L44	Fk	2.5V	BD48L25	Mm	4.4V	BD49L44	Ke	2.5V	BD49L25
Gr	4.3V	BD48L43	Fh	2.4V	BD48L24	Mk	4.3V	BD49L43	Kd	2.4V	BD49L24
Gp	4.2V	BD48L42	Fg	2.3V	BD48L23	Mh	4.2V	BD49L42	Kc	2.3V	BD49L23

●Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit
Power Supply Voltage		V _{DD} -GND	-0.3 to +10	V
Output Voltage	Nch Open Drain Output	V _{OUT}	GND-0.3 to +10	V
	CMOS Output		GND-0.3 to V _{DD} +0.3	
Power Dissipation	SSOP5 *1*3	Pd	540	mW
	VSO5 *2*3		210	
Operating Temperature		Topr	-40 to +105	°C
Ambient Storage Temperature		Tstg	-55 to +125	°C

*1 Use above Ta=25°C results in a 5.4mW loss per degree.

*2 Use above Ta=25°C results in a 2.1mW loss per degree.

*3 When a ROHM standard circuit board (70mm×70mm×1.6mm glass epoxy board) is mounted.

●Electrical Characteristics (Unless Otherwise Specified Ta=-40 to 105°C)

Parameter	Symbol	Condition	Limit			Unit
			Min.	Typ.	Max.	
Detection Voltage	V _{DET}	R _L =470kΩ, V _{DD} =H→L *1	V _{DET} (T) ×0.99	V _{DET} (T)	V _{DET} (T) ×1.01	V
Output Delay Time "L→H"	t _{PLH}	C _L =100pF R _L =100kΩ V _{out} =GND→50% *2	-	-	100	μs
Circuit Current when ON	I _{CC1}	V _{DD} =V _{DET} -0.2V *1	V _{DET} =2.3-3.1V	-	0.51	μA
			V _{DET} =3.2-4.2V	-	0.56	
			V _{DET} =4.3-5.2V	-	0.60	
			V _{DET} =5.3-6.0V	-	0.66	
Circuit Current when OFF	I _{CC2}	V _{DD} =V _{DET} +2.0V *1	V _{DET} =2.3-3.1V	-	0.75	μA
			V _{DET} =3.2-4.2V	-	0.80	
			V _{DET} =4.3-5.2V	-	0.85	
			V _{DET} =5.3-6.0V	-	0.90	
Operating Voltage Range	V _{OPL}	V _{OL} ≤0.4V, Ta=25 to 105°C, R _L =470kΩ	0.95	-	-	V
		V _{OL} ≤0.4V, Ta=-40 to 25°C, R _L =470kΩ	1.20	-	-	
'Low' Output Current (Nch)	I _{OL}	V _{DS} =0.5V, V _{DD} =1.5V, V _{DET} =2.3-6.0V	0.4	1.0	-	mA
		V _{DS} =0.5V, V _{DD} =2.4V, V _{DET} =2.7-6.0V	2.0	4.0	-	
'High' Output Current (Pch) (BD49xxx Series)	I _{OH}	V _{DS} =0.5V, V _{DD} =4.8V, V _{DET} =2.3-4.2V	0.7	1.4	-	mA
		V _{DS} =0.5V, V _{DD} =6.0V, V _{DET} =4.3-5.2V	0.9	1.8	-	
		V _{DS} =0.5V, V _{DD} =8.0V, V _{DET} =5.3-6.0V	1.1	2.2	-	
Leak Current when OFF (BD48xxx Series)	I _{leak}	V _{DD} =V _{DS} =10V *1	-	-	0.1	μA
Detection Voltage Temperature coefficient	V _{DET} /ΔT	Ta=-40°C to 105°C (Designed Guarantee)	-	±100	±360	ppm/°C
Hysteresis Voltage	ΔV _{DET}	V _{DD} =L→H→L	V _{DET} ×0.03	V _{DET} ×0.05	V _{DET} ×0.08	V

V_{DET}(T): Standard Detection Voltage(2.3V to 6.0V, 0.1V step)

R_L: Pull-up resistor to be connected between V_{OUT} and power supply.

C_L: Capacitor to be connected between V_{OUT} and GND.

Designed Guarantee. (Outgoing inspection is not done on all products.)

*1 Guarantee is Ta=25°C.

*2 t_{PLH}: V_{DD}=(V_{DET} typ.-0.5V)→(V_{DET} typ.+0.5V)

●Block Diagrams

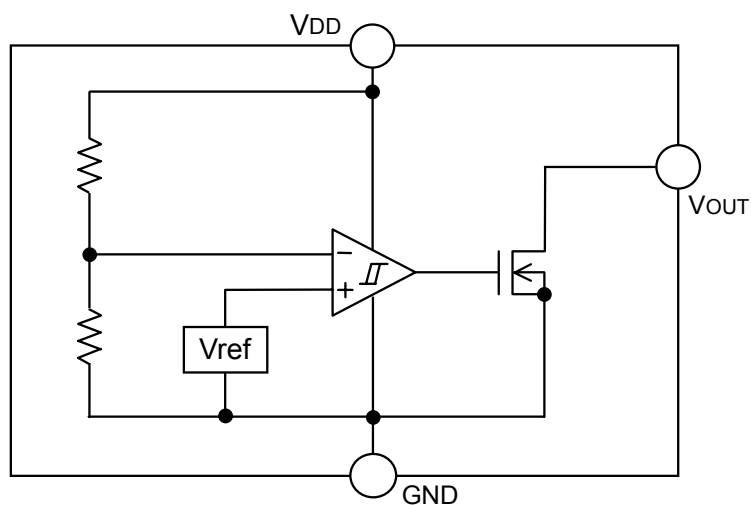


Fig.1 BD48xxx series

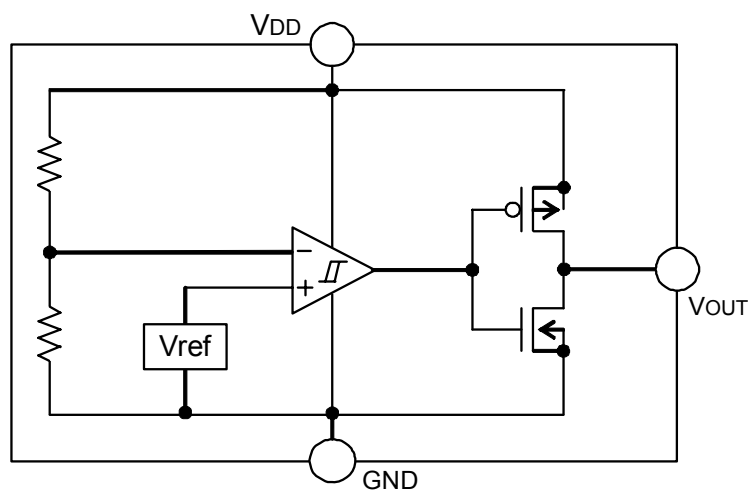
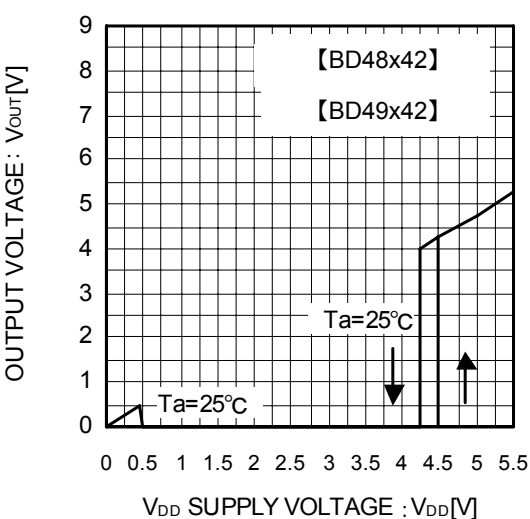
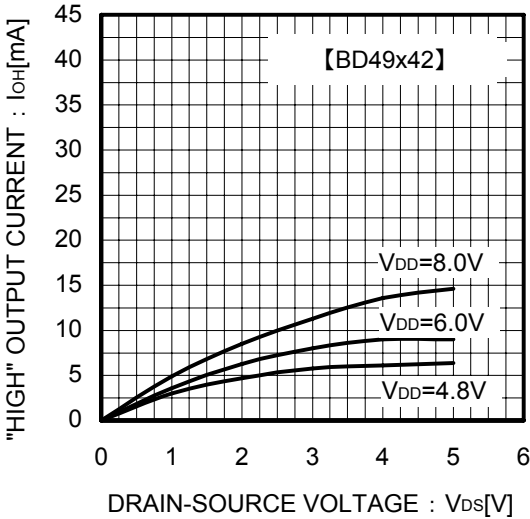
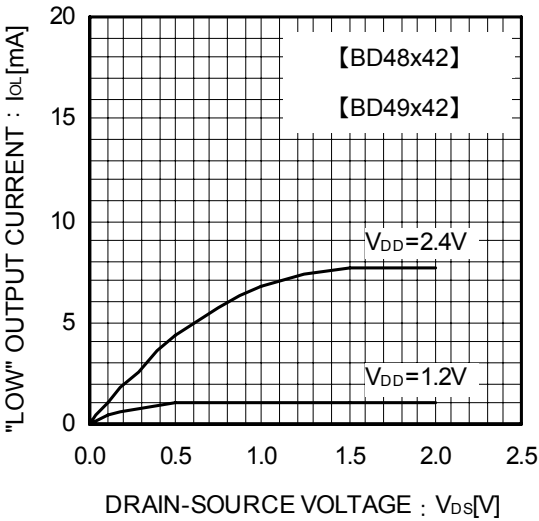
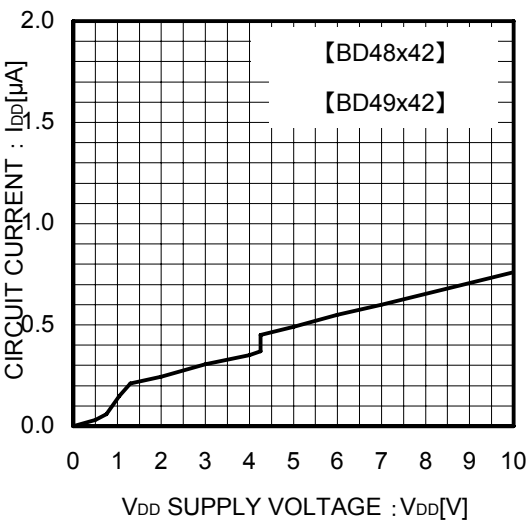


Fig.2 BD49xxx series

●Typical Performance Curves



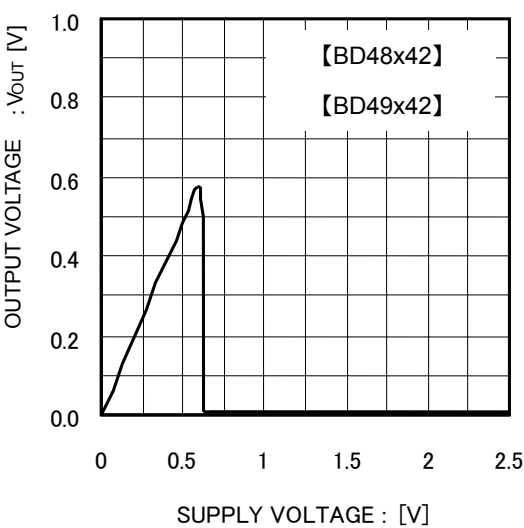


Fig.7 Operating Limit Voltage

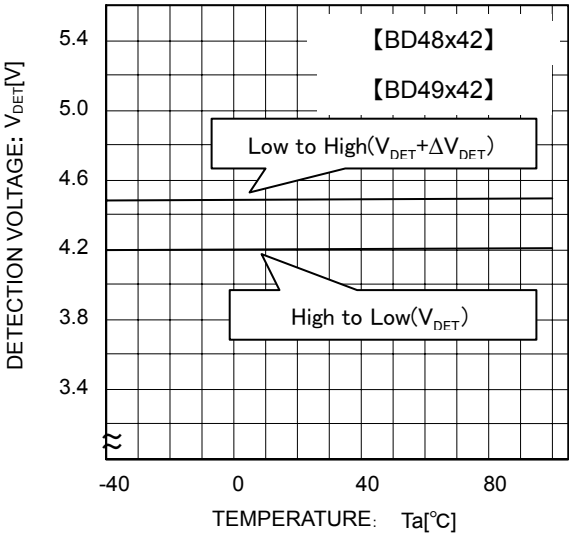


Fig.8 Detection Voltage Release Voltage

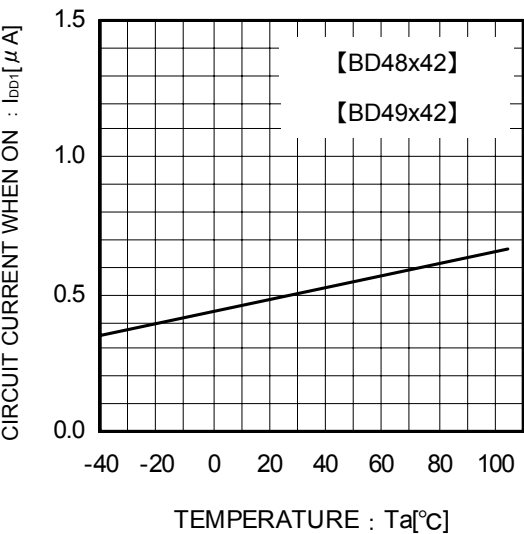


Fig.9 Circuit Current when ON

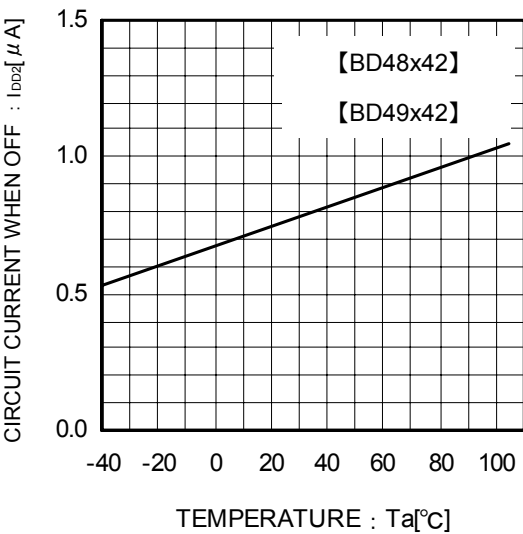


Fig.10 Circuit Current when OFF

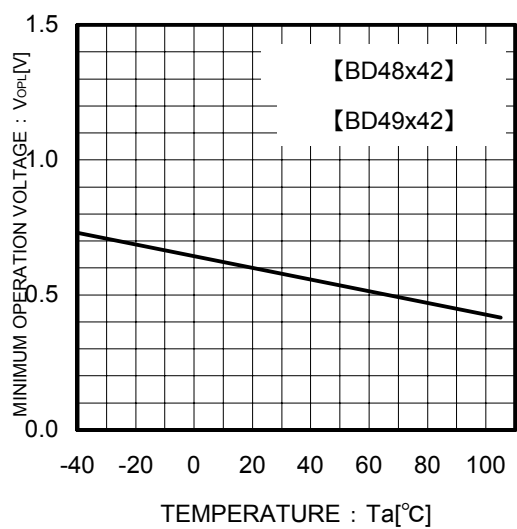


Fig.11 Operating Limit Voltage

●Application Information

Explanation of Operation

For both the open drain type (Fig.12) and the CMOS output type (Fig.13), the detection and release voltages are used as threshold voltages. When the voltage applied to the V_{DD} pins reaches the applicable threshold voltage, the V_{OUT} terminal voltage switches from either “High” to “Low” or from “Low” to “High”. Please refer to the Timing Waveform and Electrical Characteristics for information on hysteresis.

Because the BD48xxx series uses an open drain output type, it is possible to connect a pull-up resistor to V_{DD} or another power supply [The output “High” voltage (V_{OUT}) in this case becomes V_{DD} or the voltage of the other power supply].

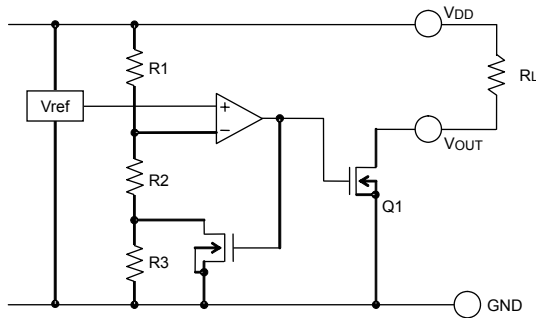


Fig.12 (BD48xxx series Internal Block Diagram)

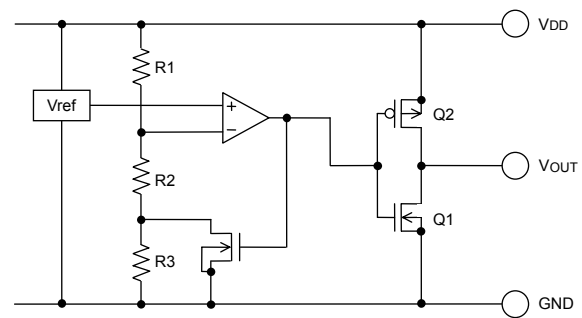


Fig.13 (BD49xxx series Internal Block Diagram)

Reference Data

Examples of Leading (t_{PLH}) and Falling (t_{PHL}) Output

Part Number	t_{PLH} (μs)	t_{PHL} (μs)
BD48x45	39.5	87.8
BD49x45	32.4	52.4

$V_{DD}=4.3V \rightarrow 5.1V$

$V_{DD}=5.1V \rightarrow 4.3V$

*This data is for reference only.

The figures will vary with the application, so please confirm actual operating conditions before use.

Timing Waveform

Example: the following shows the relationship between the input voltages V_{DD} and the output voltage V_{OUT} when the input power supply voltage V_{DD} is made to sweep up and sweep down (the circuits are those in Fig.12 and 13).

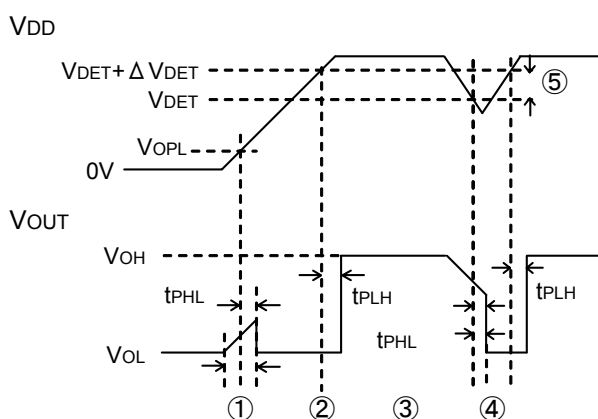


Fig.14 Timing Waveform

- ① When the power supply is turned on, the output is unsettled from after over the operating limit voltage (V_{OPL}) until t_{PHL} . Therefore it is possible that the reset signal is not valid when the rise time of V_{DD} is faster than t_{PHL} .
- ② When V_{DD} is greater than V_{OPL} but less than the reset release voltage ($V_{DET} + \Delta V_{DET}$), the output voltages will switch to Low.
- ③ If V_{DD} exceeds the reset release voltage ($V_{DET} + \Delta V_{DET}$), then V_{OUT} switches from L to H.
- ④ If V_{DD} drops below the detection voltage (V_{DET}) when the power supply is powered down or when there is a power supply fluctuation, V_{OUT} switches to L (with a delay of t_{PHL}).
- ⑤ The potential difference between the detection voltage and the release voltage is known as the hysteresis width (ΔV_{DET}). The system is designed such that the output does not flip-flop with power supply fluctuations within this hysteresis width, preventing malfunctions due to noise.

●Circuit Applications

Examples of a common power supply detection reset circuit.

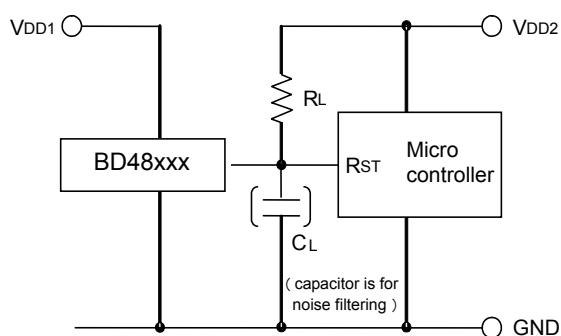


Fig.15 Open Drain Output Type

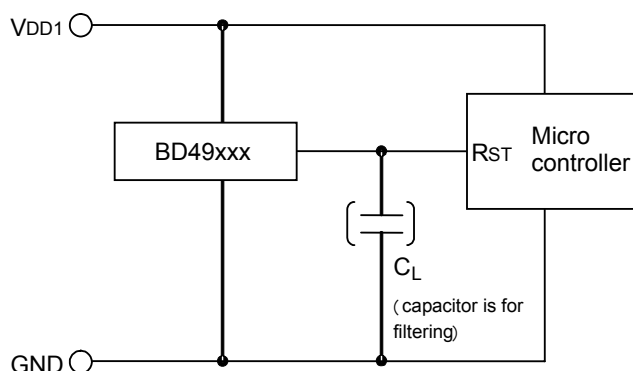


Fig.16 CMOS Output Type

Application examples of BD48xxx series (Open Drain output type) and BD49xxx series (CMOS output type) are shown below.

CASE1: the power supply of the microcontroller (V_{DD2}) differs from the power supply of the reset detection (V_{DD1}). Use an open drain output type (BD48xxx) device with a load resistance R_L attached as shown in figure 15.

CASE2: the power supply of the microcontroller (V_{DD1}) is same as the power supply of the reset detection (V_{DD1}). Use a CMOS output type (BD49xxx) device or an open drain device with a pull up resistor between output and V_{DD1} .

When a capacitance C_L for noise filtering is connected to the V_{OUT} pin (the reset signal input terminal of the microcontroller), please take into account the waveform of the rise and fall of the output voltage (V_{OUT}).

The Electrical characteristics were measured using $R_L = 470k\Omega$ and $C_L = 100pF$.

●Operational Notes**1 . Absolute maximum range**

Absolute Maximum Ratings are those values beyond which the life of a device may be destroyed. We cannot be defined the failure mode, such as short mode or open mode. Therefore a physical security countermeasure, like fuse, is to be given when a specific mode to be beyond absolute maximum ratings is considered.

2 . GND potential

GND terminal should be a lowest voltage potential every state.

Please make sure all pins, which are over ground even if, include transient feature.

3 . Electrical Characteristics

Be sure to check the electrical characteristics that are one the tentative specification will be changed by temperature, supply voltage, and external circuit.

4 . Bypass Capacitor for Noise Rejection

Please put into the capacitor of 1 μ F or more between V_{DD} pin and GND, and the capacitor of about 1000pF between V_{OUT} pin and GND, to reject noise. If extremely big capacitor is used, transient response might be late. Please confirm sufficiently for the point.

5 . Short Circuit between Terminal and Soldering

Don't short-circuit between Output pin and V_{DD} pin, Output pin and GND pin, or V_{DD} pin and GND pin. When soldering the IC on circuit board, please be unusually cautious about the orientation and the position of the IC. When the orientation is mistaken the IC may be destroyed.

6 . Electromagnetic Field

Mal-function may happen when the device is used in the strong electromagnetic field.

7 . The V_{DD} line impedance might cause oscillation because of the detection current.**8 . A V_{DD} -GND capacitor (as close connection as possible) should be used in high V_{DD} line impedance condition.****9 . Lower than the minimum input voltage makes the V_{OUT} high impedance, and it must be V_{DD} in pull up (V_{DD}) condition.****10. This IC has extremely high impedance terminals. Small leak current due to the uncleanness of PCB surface might cause unexpected operations. Application values in these conditions should be selected carefully. If the leakage is assumed between the V_{OUT} terminal and the GND terminal, the pull-up resistor should be less than 1/10 of the assumed leakage resistance.****11. External parameters**

The recommended parameter range for R_L is 10k Ω to 1M Ω . There are many factors (board layout, etc) that can affect characteristics. Please verify and confirm using practical applications.

12. Power on reset operation

Please note that the power on reset output varies with the V_{DD} rise up time. Please verify the actual operation.

13. Precautions for board inspection

Connecting low-impedance capacitors to run inspections with the board may produce stress on the IC. Therefore, be certain to use proper discharge procedure before each process of the test operation.

To prevent electrostatic accumulation and discharge in the assembly process, thoroughly ground yourself and any equipment that could sustain ESD damage, and continue observing ESD-prevention procedures in all handling, transfer and storage operations. Before attempting to connect components to the test setup, make certain that the power supply is OFF. Likewise, be sure the power supply is OFF before removing any component connected to the test setup.

14. When the power supply, is turned on because of in certain cases, momentary Rash-current flow into the IC at the logic unsettled, the couple capacitance, GND pattern of width and leading line must be considered.**Status of this document**

The Japanese version of this document is formal specification. A customer may use this translation version only for a reference to help reading the formal version.

If there are any differences in translation version of this document formal version takes priority.

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4) The Products are not subject to radiation-proof design.
- 5) Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6) In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse) is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7) De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8) Confirm that operation temperature is within the specified range described in the product specification.
- 9) ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

●Precaution for Mounting / Circuit board design

- 1) When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2) In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

●Precautions Regarding Application Examples and External Circuits

- 1) If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2) You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2) Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3) Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4) Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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QR code printed on ROHM Products label is for ROHM's internal use only.

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When disposing Products please dispose them properly using an authorized industry waste company.

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